74VCX16374

LOW VOLTAGE CMOS 16-BIT D-TYPE FLIP-FLOP (3-STATE) WITH 3.6V TOLERANT INPUTS AND OUTPUTS

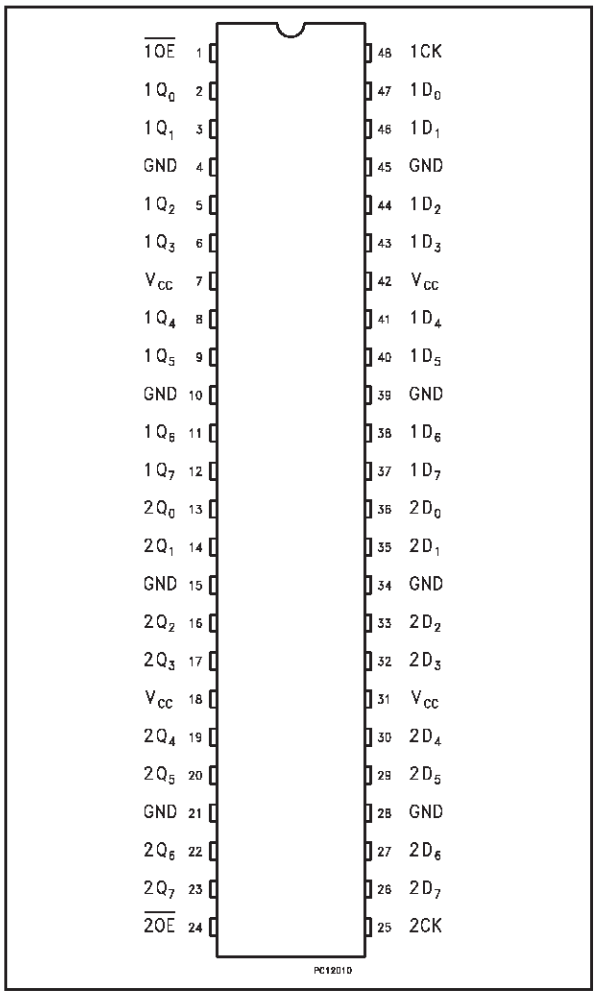
- 3.6V TOLERANT INPUTS AND OUTPUTS
- HIGH SPEED :
  t_{PD} = 3.0 ns (MAX.) at V_{CC} = 3.0 to 3.6V
  t_{PD} = 3.4 ns (MAX.) at V_{CC} = 2.3 to 2.7V
  t_{PD} = 6.8 ns (MAX.) at V_{CC} = 1.8V
- POWER DOWN PROTECTION ON INPUTS AND OUTPUTS
- SYMMETRICAL OUTPUT IMPEDANCE:
  $|I_{OH}| = I_{OL}$ = 24mA (MIN) at V_{CC} = 3.0V
  $|I_{OH}| = I_{OL}$ = 18mA (MIN) at V_{CC} = 2.3V
  $|I_{OH}| = I_{OL}$ = 6mA (MIN) at V_{CC} = 1.8V
- OPERATING VOLTAGE RANGE:
  V_{CC}(OPR) = 1.8V to 3.6V
- PIN AND FUNCTION COMPATIBLE WITH 74 SERIES 16374
- LATCH-UP PERFORMANCE EXCEEDS 300mA (JESD 17)
- ESD PERFORMANCE:
  HBM > 2000V (MIL STD 883 method 3015);
  MM > 200V

TSSOP

ORDER CODES

PACKAGE	TUBE	T & R
TSSOP		74VCX16374TTR

PIN CONNECTION



DESCRIPTION

The 74VCX16374 is a low voltage CMOS 16 BIT D-TYPE FLIP-FLOP with 3 STATE OUTPUTS NON INVERTING fabricated with sub-micron silicon gate and five-layer metal wiring C^2MOS technology. It is ideal for low power and very high speed 1.8 to 3.6V applications; it can be interfaced to 3.6V signal environment for both inputs and outputs.

These 16 bit D-TYPE flip-flops are controlled by two clock inputs (nCK) and two output enable inputs ($n\overline{OE}$).

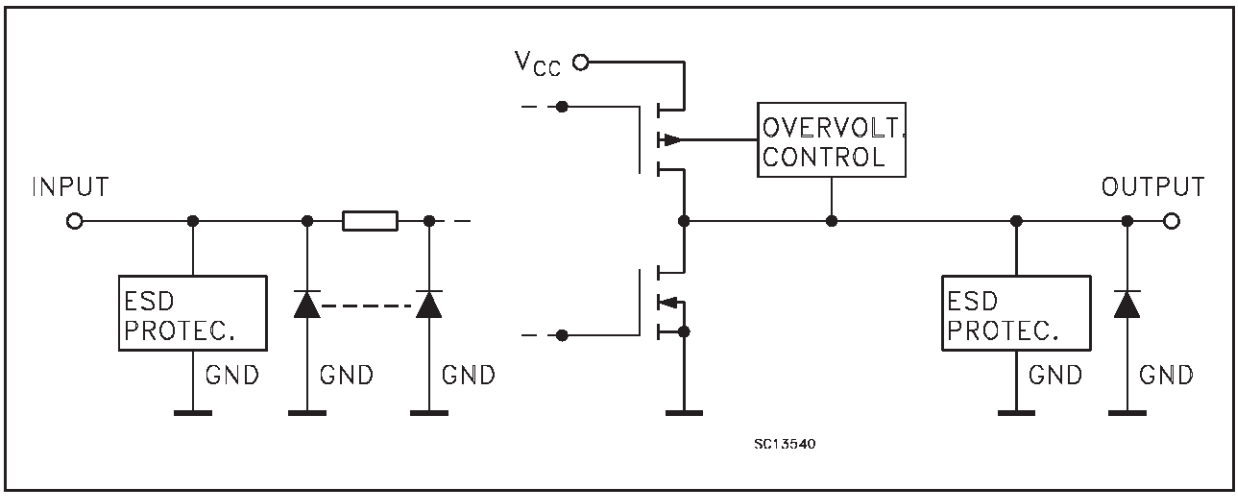
On the positive transition of the (nCK), the nQ outputs will be set to the logic state that were setup at the nD inputs.

While the ($n\overline{OE}$) input is low, the 8 outputs (nQ) will be in a normal state (HIGH or LOW logic level) and while high level the outputs will be in a high impedance state.

Any output control does not affect the internal operation of flip flops; that is, the old data can be retained or the new data can be entered even while the outputs are off.

All inputs and outputs are equipped with protection circuits against static discharge, giving them 2KV ESD immunity and transient excess voltage.

INPUT AND OUTPUT EQUIVALENT CIRCUIT



PIN DESCRIPTION

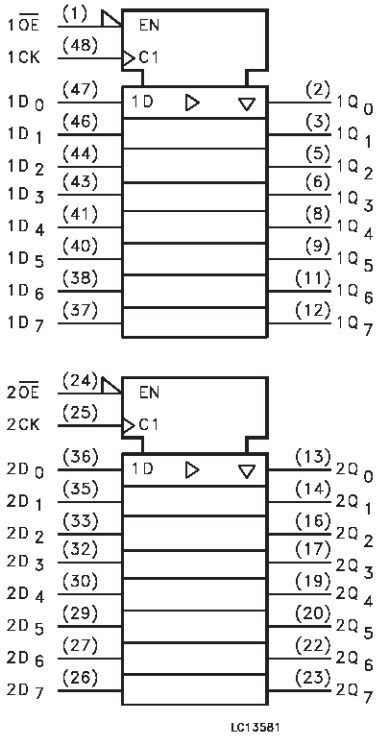
PIN No	SYMBOL	NAME AND FUNCTION
1	$1\overline{OE}$	3 State Output Enable Input (Active LOW)
2, 3, 5, 6, 8, 9, 11, 12	1Q0 to 1Q7	3-State Outputs
13, 14, 16, 17, 19, 20, 22, 23	2Q0 to 2Q7	3-State Outputs
24	$2\overline{OE}$	3 State Output Enable Input (Active LOW)
25	2CK	Clock Input
36, 35, 33, 32, 30, 29, 27, 26	2D0 to 2D7	Data Inputs
47, 46, 44, 43, 41, 40, 38, 37	1D0 to 1D7	Data Inputs
48	1CK	Clock Input
4, 10, 15, 21, 28, 34, 39, 45	GND	Ground (0V)
7, 18, 31, 42	V_{CC}	Positive Supply Voltage

TRUTH TABLE

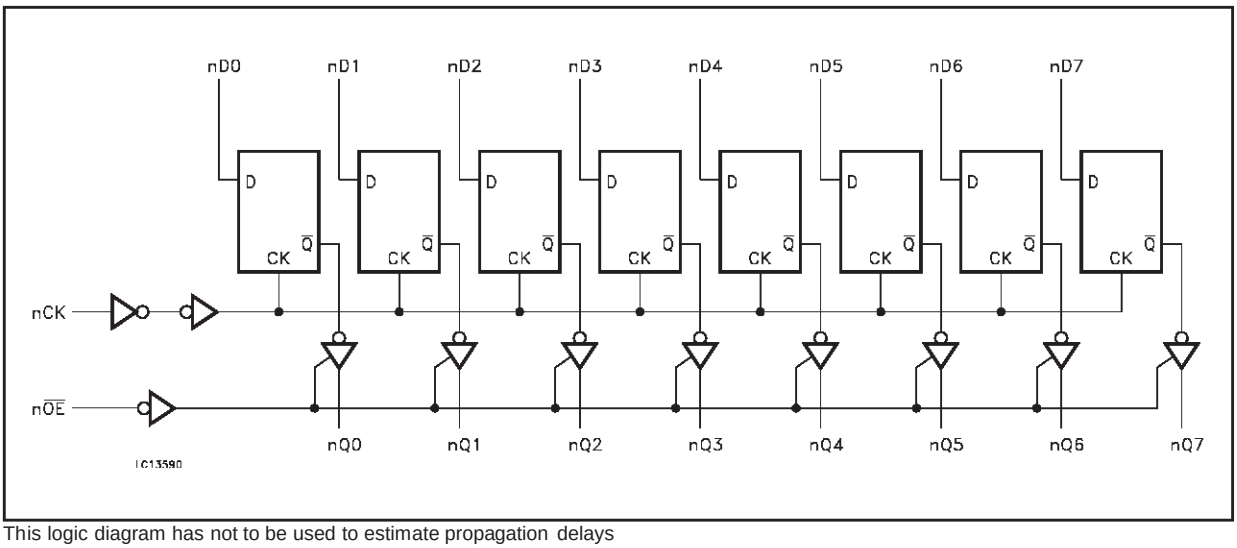
INPUTS			OUTPUT
$\overline{OE}$	CK	D	Q
H	X	X	Z
L	⎍	X	NO CHANGE*
L	⎍	L	L
L	⎍	H	H

X : Don't Care
Z : High Impedance

IEC LOGIC SYMBOLS



LOGIC DIAGRAM



This logic diagram has not to be used to estimate propagation delays

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{CC}	Supply Voltage	-0.5 to +4.6	V
V_I	DC Input Voltage	-0.5 to +4.6	V
V_O	DC Output Voltage (OFF State)	-0.5 to +4.6	V
V_O	DC Output Voltage (High or Low State) (note 1)	-0.5 to V_{CC} + 0.5	V
I_{IK}	DC Input Diode Current	- 50	mA
I_{OK}	DC Output Diode Current (note 2)	- 50	mA
I_O	DC Output Current	± 50	mA
I_{CC} or I_{GND}	DC V_{CC} or Ground Current per Supply Pin	± 100	mA
P_D	Power Dissipation	400	mW
T_{stg}	Storage Temperature	-65 to +150	°C
T_L	Lead Temperature (10 sec)	300	°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied
1) I_O absolute maximum rating must be observed
2) $V_O < GND$, $V_O > V_{CC}$

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Value	Unit
V_{CC}	Supply Voltage	1.8 to 3.6	V
V_I	Input Voltage	-0.3 to 3.6	V
V_O	Output Voltage (OFF State)	0 to 3.6	V
V_O	Output Voltage (High or Low State)	0 to V_{CC}	V
I_{OH}, I_{OL}	High or Low Level Output Current (V_{CC} = 3.0 to 3.6V)	± 24	mA
I_{OH}, I_{OL}	High or Low Level Output Current (V_{CC} = 2.3 to 2.7V)	± 18	mA
I_{OH}, I_{OL}	High or Low Level Output Current (V_{CC} = 1.8V)	± 6	mA
T_{op}	Operating Temperature	-55 to 125	°C
dt/dv	Input Rise and Fall Time (note 1)	0 to 10	ns/V

1) V_{IN} from 0.8V to 2V at V_{CC} = 3.0V

DC SPECIFICATIONS (2.7V < V_{CC} ≤ 3.6V unless otherwise specified)

Symbol	Parameter	Test Condition		Value				Unit
		V_{CC} (V)		-40 to 85 °C		-55 to 125 °C		
				Min.	Max.	Min.	Max.	
V_{IH}	High Level Input Voltage	2.7 to 3.6		2.0		2.0		V
V_{IL}	Low Level Input Voltage				0.8		0.8	
V_{OH}	High Level Output Voltage	2.7 to 3.6	I_O=-100 µA	V_{CC}-0.2		V_{CC}-0.2		V
		2.7	I_O=-12 mA	2.2		2.2		
		3.0	I_O=-18 mA	2.4		2.4		
			I_O=-24 mA	2.2		2.2		
V_{OL}	Low Level Output Voltage	2.7 to 3.6	I_O=100 µA		0.2		0.2	V
		2.7	I_O=12 mA		0.4		0.4	
		3.0	I_O=18 mA		0.4		0.4	
			I_O=24 mA		0.55		0.55	
I_I	Input Leakage Current	2.7 to 3.6	V_I = 0 to 3.6V		± 5		± 5	µA
I_{off}	Power Off Leakage Current	0	V_I or V_O = 0 to 3.6V		10		10	µA
I_{OZ}	High Impedance Output Leakage Current	2.7 to 3.6	V_I = V_{IH} or V_{IL} V_O = 0 to 3.6V		± 10		± 10	µA
I_{CC}	Quiescent Supply Current	2.7 to 3.6	V_I = V_{CC} or GND		20		20	µA
			V_I or V_O = V_{CC} to 3.6V		± 20		± 20	
ΔI_{CC}	I_{CC} incr. per Input	2.7 to 3.6	V_{IH} = V_{CC} - 0.6V		750		750	µA

DC SPECIFICATIONS (2.3V < V_{CC} ≤ 2.7V unless otherwise specified)

Symbol	Parameter	Test Condition		Value				Unit
		V_{CC} (V)		-40 to 85 °C		-55 to 125 °C		
				Min.	Max.	Min.	Max.	
V_{IH}	High Level Input Voltage	2.3 to 2.7		1.6		1.6		V
V_{IL}	Low Level Input Voltage				0.7		0.7	
V_{OH}	High Level Output Voltage	2.3 to 2.7	I_O=-100 µA	V_{CC}-0.2		V_{CC}-0.2		V
		2.3	I_O=-6 mA	2.0		2.0		
			I_O=-12 mA	1.8		1.8		
			I_O=-18 mA	1.7		1.7		
V_{OL}	Low Level Output Voltage	2.3 to 2.7	I_O=100 µA		0.2		0.2	V
		2.3	I_O=12 mA		0.4		0.4	
			I_O=18 mA		0.6		0.6	
I_I	Input Leakage Current	2.3 to 2.7	V_I = 0 to 3.6V		± 5		± 5	µA
I_{off}	Power Off Leakage Current	0	V_I or V_O = 0 to 3.6V		10		10	µA
I_{OZ}	High Impedance Output Leakage Current	2.3 to 2.7	V_I = V_{IH} or V_{IL} V_O = 0 to 3.6V		± 10		± 10	µA
I_{CC}	Quiescent Supply Current	2.3 to 2.7	V_I = V_{CC} or GND		20		20	µA
			V_I or V_O = V_{CC} to 3.6V		± 20		± 20	

DC SPECIFICATIONS (1.8V ≤ V_{CC} ≤ 2.3V unless otherwise specified)

Symbol	Parameter	Test Condition		Value				Unit
		V_{CC} (V)		-40 to 85 °C		-55 to 125 °C		
				Min.	Max.	Min.	Max.	
V_{IH}	High Level Input Voltage	1.8 to 2.3		0.7 VCC		0.7 VCC		V
V_{IL}	Low Level Input Voltage				0.2 VCC		0.2 VCC	V
V_{OH}	High Level Output Voltage	1.8	I_O=-100 µA	V_{CC}-0.2		V_{CC}-0.2		V
			I_O=-6 mA	1.4		1.4		
V_{OL}	Low Level Output Voltage	1.8	I_O=100 µA		0.2		0.2	V
			I_O=6 mA		0.3		0.3	
I_I	Input Leakage Current	1.8	V_I = 0 to 3.6V		± 5		± 5	µA
I_{off}	Power Off Leakage Current	0	V_I or V_O = 0 to 3.6V		10		10	µA
I_{OZ}	High Impedance Output Leakage Current	1.8	V_I = V_{IH} or V_{IL} V_O = 0 to 3.6V		± 10		± 10	µA
I_{CC}	Quiescent Supply Current	1.8	V_I = V_{CC} or GND		20		20	µA
			V_I or V_O = V_{CC} to 3.6V		± 20		± 20	

DYNAMIC SWITCHING CHARACTERISTICS (T_a = 25°C, Input $t_r = t_f$ = 2.0ns, C_L = 30pF, R_L = 500Ω)

Symbol	Parameter	Test Condition		Value			Unit
		V_{CC} (V)		T_A = 25 °C			
				Min.	Typ.	Max.	
V_{OLP}	Dynamic Low Voltage Quiet Output (note 1, 3)	1.8	V_{IL} = 0V V_{IH} = V_{CC}		0.25		V
		2.5			0.6		
		3.3			0.8		
V_{OLV}	Dynamic Low Voltage Quiet Output (note 1, 3)	1.8	V_{IL} = 0V V_{IH} = V_{CC}		-0.25		V
		2.5			-0.6		
		3.3			-0.8		
V_{OHV}	Dynamic High Voltage Quiet Output (note 2, 3)	1.8	V_{IL} = 0V V_{IH} = V_{CC}		1.5		V
		2.5			1.9		
		3.3			2.2		

1) Number of outputs defined as "n". Measured with "n-1" outputs switching from HIGH to LOW or LOW to HIGH. The remaining output is measured in the LOW state.
2) Number of outputs defined as "n". Measured with "n-1" outputs switching from HIGH to LOW or LOW to HIGH. The remaining output is measured in the HIGH state.
3) Parameters guaranteed by design.

AC ELECTRICAL CHARACTERISTICS (C_L = 30pF, R_L = 500Ω, Input $t_r = t_f$ = 2.0ns)

Symbol	Parameter	Test Condition		Value				Unit
		V_{CC} (V)		-40 to 85 °C		-55 to 125 °C		
				Min.	Max.	Min.	Max.	
t_{PLH} t_{PHL}	Propagation Delay Time CK to Qn	1.8		1.5	6.8	1.5	8.0	ns
		2.3 to 2.7		1.0	3.4	1.0	4.3	
		3.0 to 3.6		0.8	3.0	0.8	4.1	
t_{PZL} t_{PZH}	Output Enable Time	1.8		1.5	9.2	1.5	10.6	ns
		2.3 to 2.7		1.0	4.6	1.0	6.0	
		3.0 to 3.6		0.8	3.5	0.8	5.4	
t_{PLZ} t_{PHZ}	Output Disable Time	1.8		1.5	6.8	1.5	8.0	ns
		2.3 to 2.7		1.0	3.8	1.0	4.7	
		3.0 to 3.6		0.8	3.5	0.8	4.2	
t_s	Setup TIme, HIGH or LOW level Dn to CK	1.8		2.5		2.5		ns
		2.3 to 2.7		1.5		1.5		
		3.0 to 3.6		1.5		1.5		
t_h	Hold Time High or LOW level Dn to CK	1.8		1.0		1.0		ns
		2.3 to 2.7		1.0		1.0		
		3.0 to 3.6		1.0		1.0		
t_w	CK Pulse Width, HIGH	1.8		4.0		4.0		ns
		2.3 to 2.7		1.5		1.5		
		3.0 to 3.6		1.5		1.5		
f_{MAX}	Clock Pulse Frequency	1.8		125		110		MHz
		2.3 to 2.7		200		190		
		3.0 to 3.6		250		235		
t_{OSLH} t_{OSHL}	Output To Output Skew Time (note1, 2)	1.8			0.75		0.75	ns
		2.3 to 2.7			0.5		0.5	
		3.0 to 3.6			0.5		0.5	

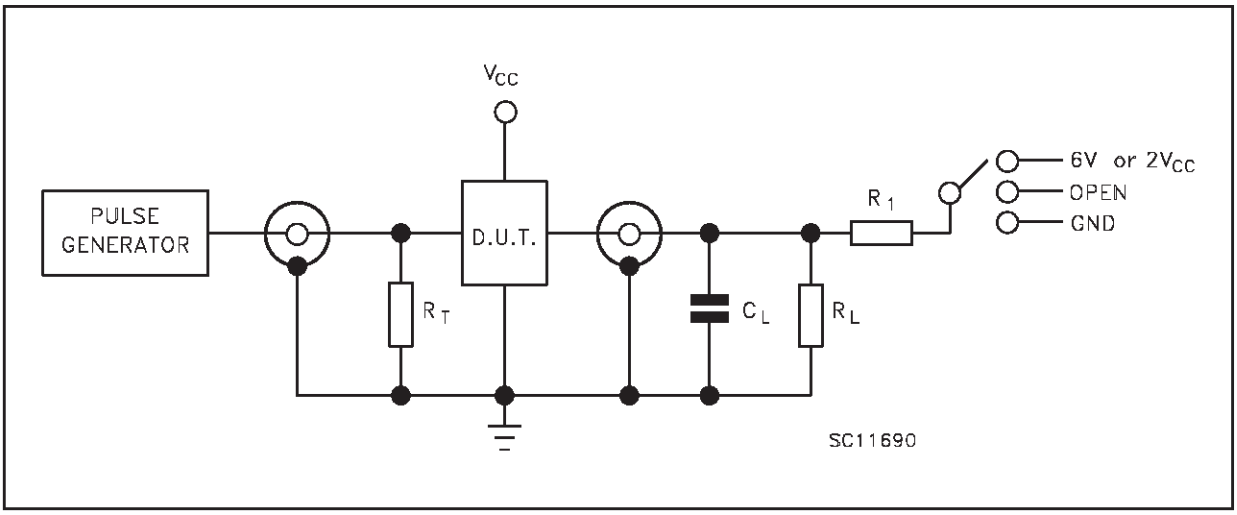
1) Skew is defined as the absolute value of the difference between the actual propagation delay for any two outputs of the same device switching in the same direction, either HIGH or LOW ($t_{OSLH} = |t_{PLHm} - t_{PLHn}|$, $t_{OSHL} = |t_{PHLm} - t_{PHLn}|$)
2) Parameter guaranteed by design

CAPACITIVE CHARACTERISTICS

Symbol	Parameter	Test Condition		Value			Unit
		V_{CC} (V)		T_A = 25 °C			
				Min.	Typ.	Max.	
C_{IN}	Input Capacitance	1.8, 2.5 or 3.3	V_{IN} = 0 or V_{CC}		6		pF
C_{OUT}	Output Capacitance	1.8, 2.5 or 3.3	V_{IN} = 0 or V_{CC}		7		pF
C_{PD}	Power Dissipation Capacitance (note 1)	1.8, 2.5 or 3.3	f_{IN} = 10MHz V_{IN} = 0 or V_{CC}		20		pF

1) C_{PD} is defined as the value of the IC's internal equivalent capacitance which is calculated from the operating current consumption without load. (Refer to Test Circuit). Average operating current can be obtained by the following equation. $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}/16$ (per circuit)

TEST CIRCUIT



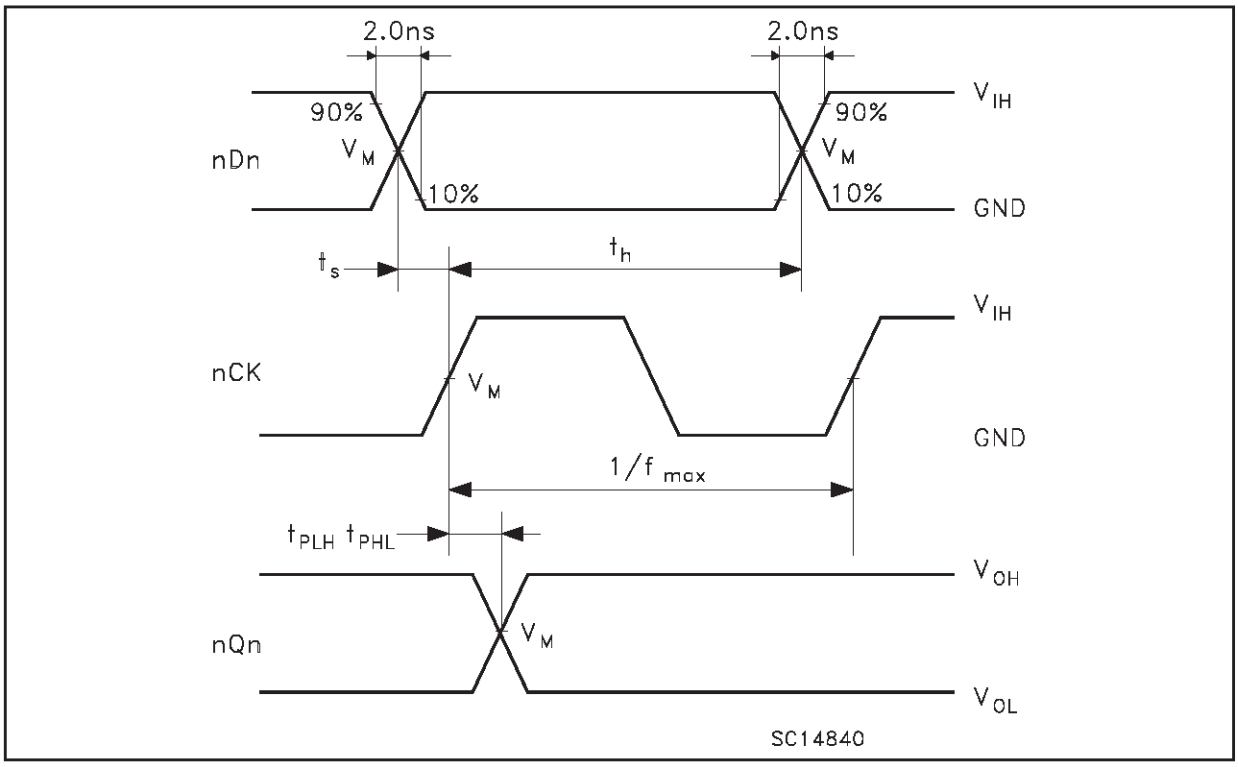
TEST	SWITCH
t_{PLH}, t_{PHL}	Open
t_{PZL}, t_{PLZ} (V_{CC} = 3.0 to 3.6V)	6V
t_{PZL}, t_{PLZ} (V_{CC} = 2.3 to 2.7V or 1.8V)	$2V_{CC}$
t_{PZH}, t_{PHZ}	GND

C_L = 30 pF or equivalent (includes jig and probe capacitance)
R_L = R1 = 500Ω or equivalent
R_T = Z_{OUT} of pulse generator (typically 50Ω)

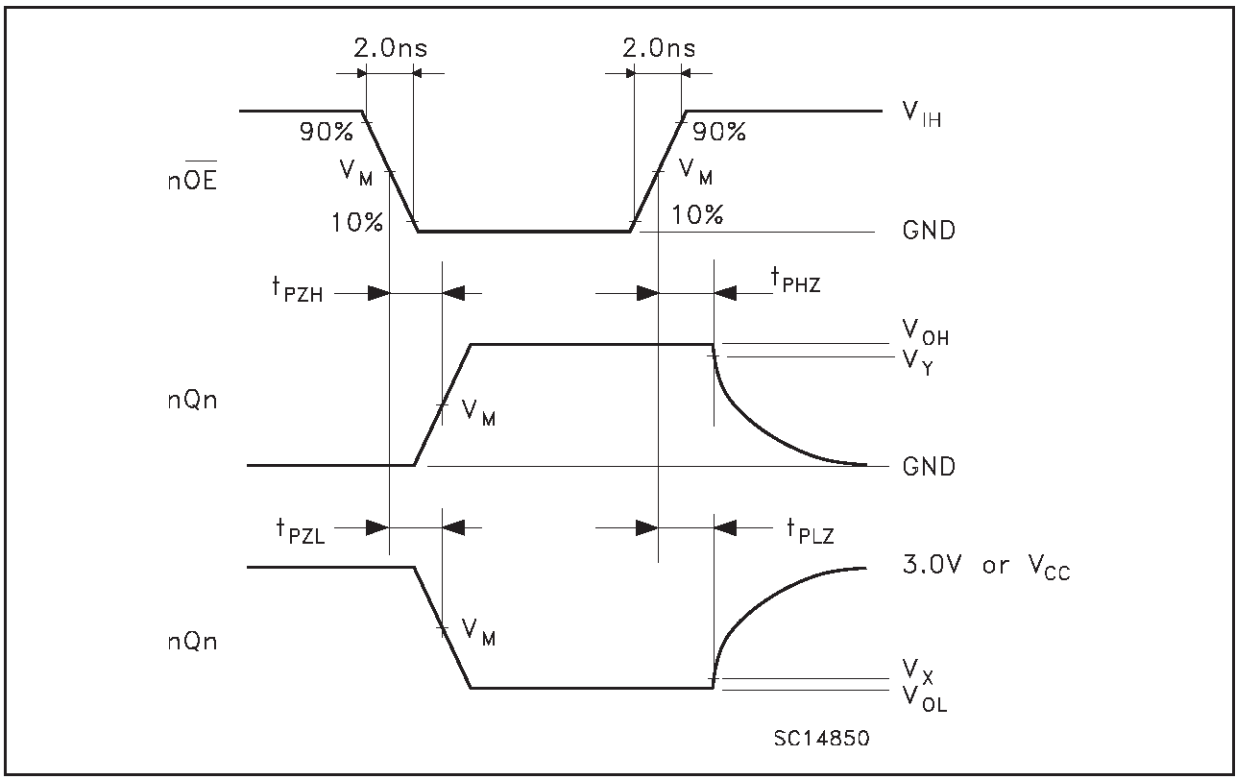
WAVEFORM SYMBOL VALUES

Symbol	V_{CC}		
	3.0 to3.6V	2.3 to 2.7V	1.8V
V_{IH}	2.7V	V_{CC}	V_{CC}
V_M	1.5V	$V_{CC}/2$	$V_{CC}/2$
V_X	V_{OL} + 0.3V	V_{OL} + 0.15V	V_{OL} + 0.15V
V_Y	V_{OH} - 0.3V	V_{OH} - 0.15V	V_{OH} - 0.15V

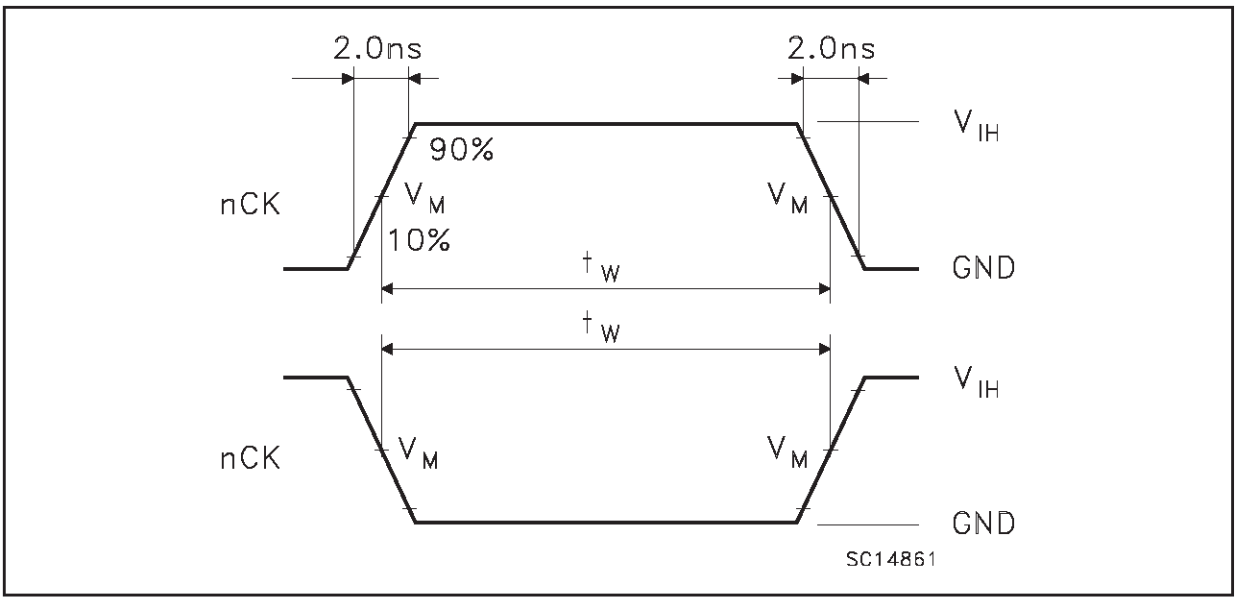
WAVEFORM 1: nCK TO Qn PROPAGATION DELAYS, nCK MAXIMUM FREQUENCY, Dn TO nCK SETUP AND HOLD TIMES (f=1MHz; 50% duty cycle)



WAVEFORM 2: OUTPUT ENABLE AND DISABLE TIME (f=1MHz; 50% duty cycle)



WAVEFORM 3 : nCK MINIMUM PULSE WIDTH (f=1MHz; 50% duty cycle)



TSSOP48 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			1.1			0.043
A1	0.05		0.15	0.002		0.006
A2		0.9			0.035	
b	0.17		0.27	0.0067		0.011
c	0.09		0.20	0.0035		0.0079
D	12.4		12.6	0.408		0.496
E	7.95		8.25	0.313		0.325
E1	6.0		6.2	0.236		0.244
e		0.5 BSC			0.0197 BSC	
K	0°		8°	0°		8°
L	0.50		0.75	0.020		0.030